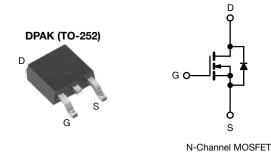
**Vishay Siliconix** 



**D** Series Power MOSFET



PRODUCT SUMMARY				
$V_{DS}$ (V) at $T_J$ max.	550			
R <sub>DS(on)</sub> max. (Ω) at 25 °C	$V_{GS} = 10 V$	3.2		
Q <sub>g</sub> max. (nC)	12			
Q <sub>gs</sub> (nC)	2			
Q <sub>gd</sub> (nC)	3			
Configuration	Single			

### FEATURES

- Optimal design
  - Low area specific on-resistance
  - Low input capacitance (C<sub>iss</sub>)
  - Reduced capacitive switching losses
  - High body diode ruggedness
  - Avalanche energy rated (UIS)
- Optimal efficiency and operation
  - Low cost
  - Simple gate drive circuitry
  - Low figure-of-merit (FOM): Ron x Qg
  - Fast switching
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

#### **APPLICATIONS**

- Consumer electronics
  - Displays (LCD or plasma TV)
- · Server and telecom power supplies
  - SMPS
- Industrial
  - Welding
  - Induction heating
  - Motor drives
- Battery chargers

ORDERING INFORMATION				
Package	DPAK (TO-252)	DPAK (TO-252)	DPAK (TO-252)	
Lead (Pb)-free and halogen-free	SiHD3N50D-GE3	SiHD3N50DT1-GE3	SiHD3N50DT4-GE3	
Lead (Fb)-free and halogen-free	SiHD3N50DT5-GE3	SiHD3N50D-BE3	-	
Lead (Pb)-free	SiHD3N50D-E3	-	-	

<b>ABSOLUTE MAXIMUM RATINGS</b> (T <sub>C</sub> = 25 °C, unless otherwise noted)				
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-source voltage		V <sub>DS</sub>	500	
Gate-source voltage		V	± 30	V
Gate-source voltage AC (f > 1 Hz)		V <sub>GS</sub>	30	
Continuous ducin suurant (T 150 °C)	$V_{GS}$ at 10 V $T_C = 25 \degree C$		3.0	
Continuous drain current ( $T_J = 150 \ ^\circ C$ )	$T_{\rm C} = 100 ^{\circ}{\rm C}$	, I <sub>D</sub>	1.9	А
Pulsed drain current <sup>a</sup>	I <sub>DM</sub>	5.5		
Linear derating factor			0.56	W/°C
Single pulse avalanche energy <sup>b</sup>		E <sub>AS</sub>	10.4	mJ
Maximum power dissipation		PD	69	W
Operating junction and storage temperature range		T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C
Drain-source voltage slope	T <sub>J</sub> = 125 °C	dV/dt	24	
Reverse diode dV/dt <sup>d</sup>		uv/di	0.22	V/ns
Soldering recommendations (peak temperature) <sup>c</sup>	peak temperature) <sup>c</sup> For 10 s		300	°C

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 50 V, starting  $T_J$  = 25 °C, L = 2.3 mH,  $R_g$  = 25  $\Omega,$   $I_{AS}$  = 3 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D$ , starting  $T_J = 25 \ ^{\circ}C$ 

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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum junction-to-ambient	R <sub>thJA</sub>	-	62	°C/W
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	1.8	0/11

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		•		•	•	•	•
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	500	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 250 μA	-	0.56	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	= V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	3	-	5	V
Gate-source leakage	I <sub>GSS</sub>		$V_{GS} = \pm 30 V$	-	-	± 100	nA
Zava gata valtaga drain avvent	1	V <sub>DS</sub> =	= 500 V, V <sub>GS</sub> = 0 V	-	-	1	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 400 V	∕, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	10	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	$V_{GS} = 10 V$	I <sub>D</sub> = 1.5 A	-	2.6	3.2	Ω
Forward transconductance <sup>a</sup>	g <sub>fs</sub>	V <sub>DS</sub>	= 8 V, I <sub>D</sub> = 1.5 A	-	1	-	S
Dynamic							
Input capacitance	C <sub>iss</sub>		V <sub>GS</sub> = 0 V,	-	175	-	
Output capacitance	C <sub>oss</sub>		$V_{DS} = 100 V,$	-	21	-	1
Reverse transfer capacitance	C <sub>rss</sub>		f = 1 MHz	-	5	-	
Effective output capacitance, energy related <sup>b</sup>	C <sub>o(er)</sub>	$V_{DS} = 0 V$ to 400 V, $V_{GS} = 0 V$		-	21	-	pF
Effective output capacitance, time related <sup>c</sup>	C <sub>o(tr)</sub>			-	26	-	
Total gate charge	Qg			-	6	12	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V I <sub>D</sub> = 1.5 A, V <sub>DS</sub> = 400 V		-	2	-	nC
Gate-drain charge	Q <sub>gd</sub>			-	3	-	
Turn-on delay time	t <sub>d(on)</sub>	$V_{DD} = 400 \text{ V}, \text{ I}_D = 1.5 \text{ A}$ $R_g = 9.1 \Omega, \text{ V}_{GS} = 10 \text{ V}$		-	12	24	
Rise time	t <sub>r</sub>			-	9	18	
Turn-off delay time	t <sub>d(off)</sub>			-	11	22	ns
Fall time	t <sub>f</sub>			-	13	26	
Gate input resistance	Rg	f = 1 MHz, open drain		-	3.3	-	Ω
Drain-Source Body Diode Characteristic	cs						
Continuous source-drain diode current	١ <sub>S</sub>	MOSFET symbol showing the integral reverse P - N junction diode		-	-	3	
Pulsed diode forward current	I <sub>SM</sub>			-	-	12	A
Diode forward voltage	V <sub>SD</sub>	T <sub>J</sub> = 25 °C, I <sub>S</sub> = 1.5 A, V <sub>GS</sub> = 0 V		-	-	1.2	V
Reverse recovery time	t <sub>rr</sub>	$T_J = 25 ^{\circ}\text{C}, I_F = I_S = 1.5 \text{A},$ dl/dt = 100 A/µs, V <sub>B</sub> = 20 V		-	293	-	ns
Reverse recovery charge	Q <sub>rr</sub>			-	0.74	-	μC
Reverse recovery current	I <sub>RRM</sub>		$100 \pi \mu s, v_{\rm R} = 20 v$	-	5	-	Α

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

c.  $C_{oss(tr)}$  is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 



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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

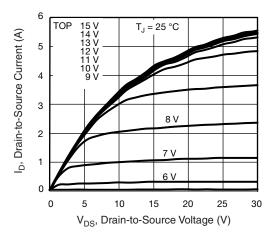


Fig. 1 - Typical Output Characteristics

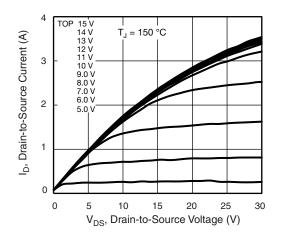
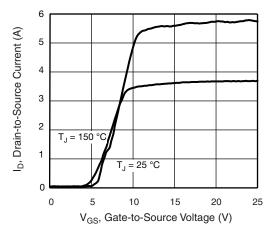


Fig. 2 - Typical Output Characteristics





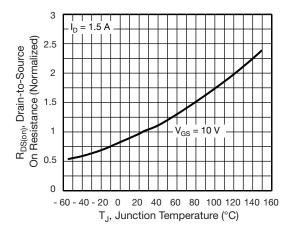


Fig. 4 - Normalized On-Resistance vs. Temperature

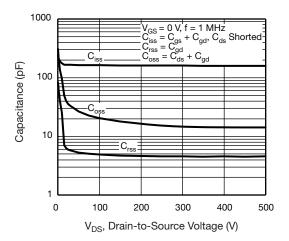


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

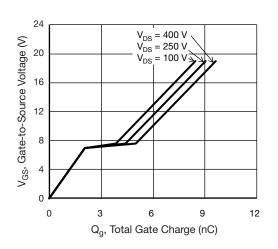


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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3 chnical questions, contact: hym@visha Document Number: 91495

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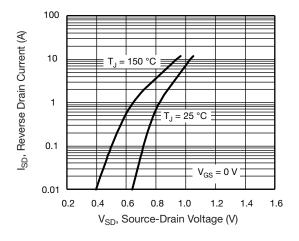
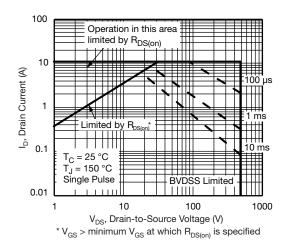


Fig. 7 - Typical Source-Drain Diode Forward Voltage





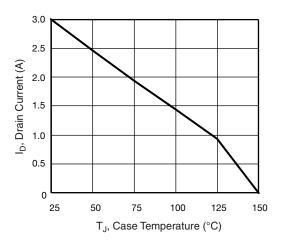


Fig. 9 - Maximum Drain Current vs. Case Temperature

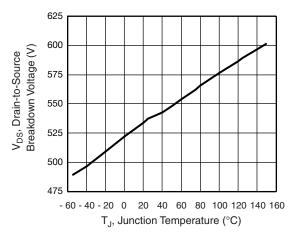
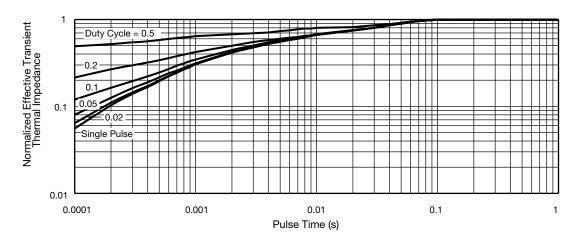


Fig. 10 - Typical Drain-to-Source Voltage vs. Temperature





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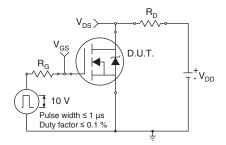


Fig. 12 - Switching Time Test Circuit

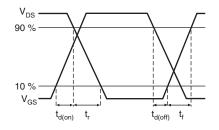


Fig. 13 - Switching Time Waveforms

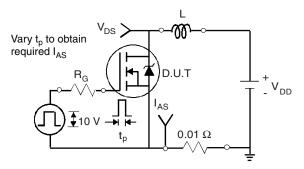


Fig. 14 - Unclamped Inductive Test Circuit

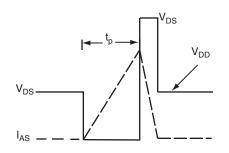


Fig. 15 - Unclamped Inductive Waveforms

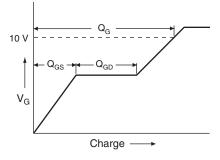


Fig. 16 - Basic Gate Charge Waveform

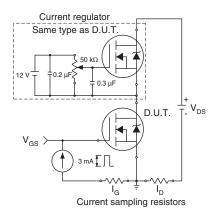
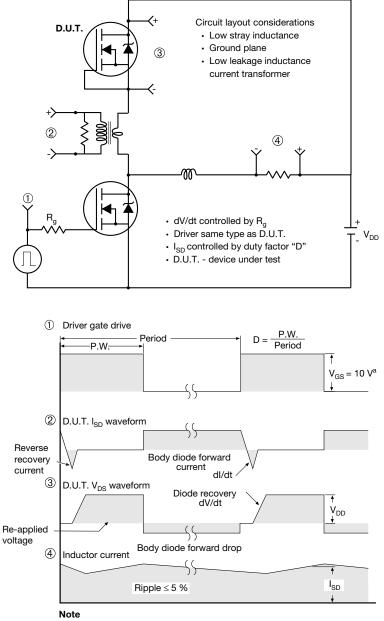


Fig. 17 - Gate Charge Test Circuit



#### Peak Diode Recovery dV/dt Test Circuit



a.  $V_{GS} = 5 V$  for logic level devices

Fig. 18 - For N-Channel

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**TO-252AA Case Outline** 

### VERSION 1: FACILITY CODE = Y







	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
E	6.35	6.73	
E1	4.32	-	
Н	9.40	10.41	
е	2.28 BSC		
e1	4.56 BSC		
L	1.40	1.78	
L3	0.89	1.27	
L4	-	1.02	
L5	1.01	1.52	

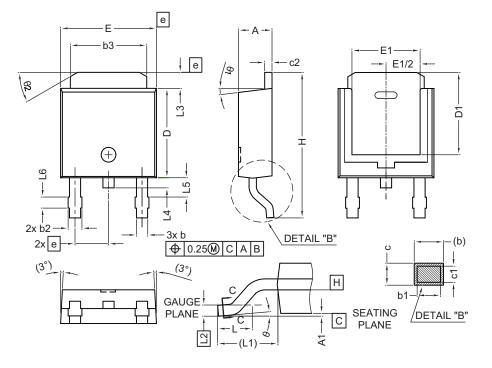
#### Note

• Dimension L3 is for reference only



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### VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
A	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	-	
E	6.35	6.73	
E1	4.32	-	
e	2.29 BSC		
Н	9.94	10.34	

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74	ref.	
L2	0.51	BSC	
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25°	35°	

#### Notes

• Dimensioning and tolerance confirm to ASME Y14.5M-1994

• All dimensions are in millimeters. Angles are in degrees

• Heat sink side flash is max. 0.8 mm

Radius on terminal is optional

ECN: E19-0649-Rev. Q, 16-Dec-2019 DWG: 5347



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## **RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)**



Recommended Minimum Pads Dimensions in Inches/(mm)

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